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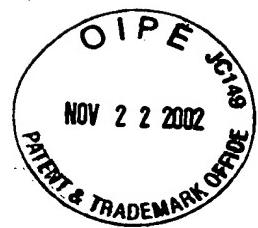
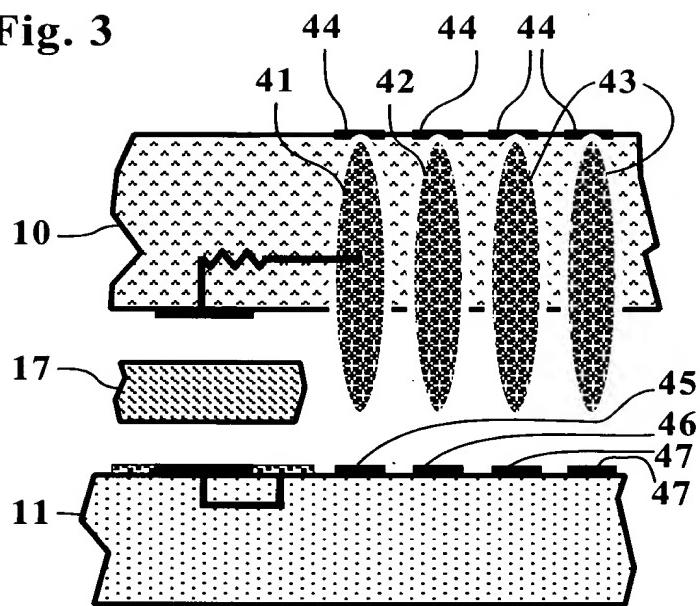
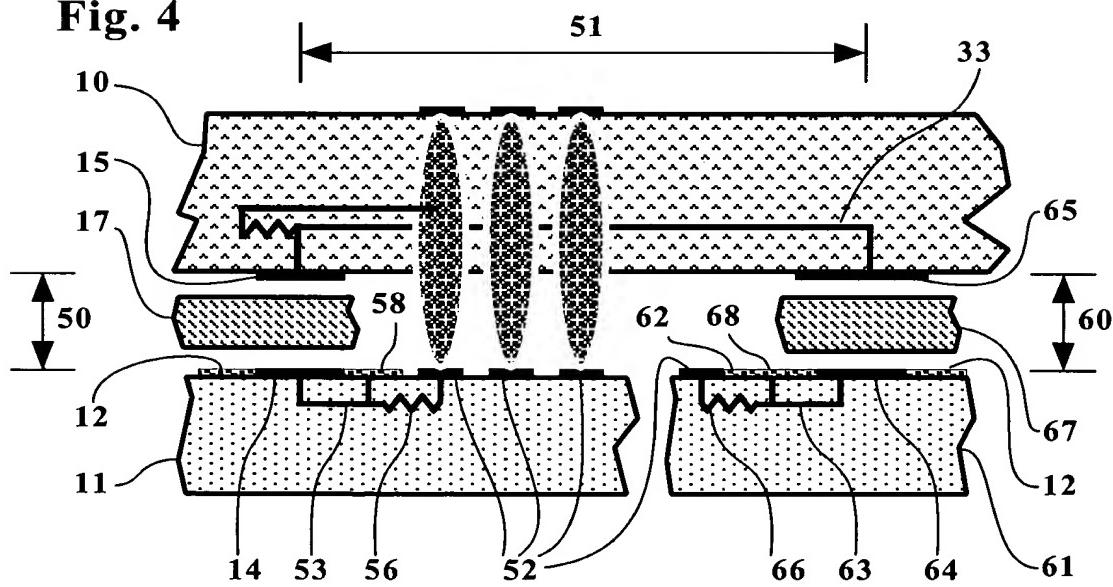


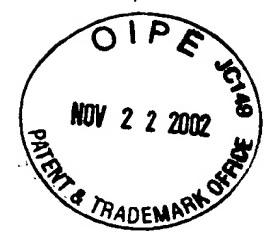
Fig. 3



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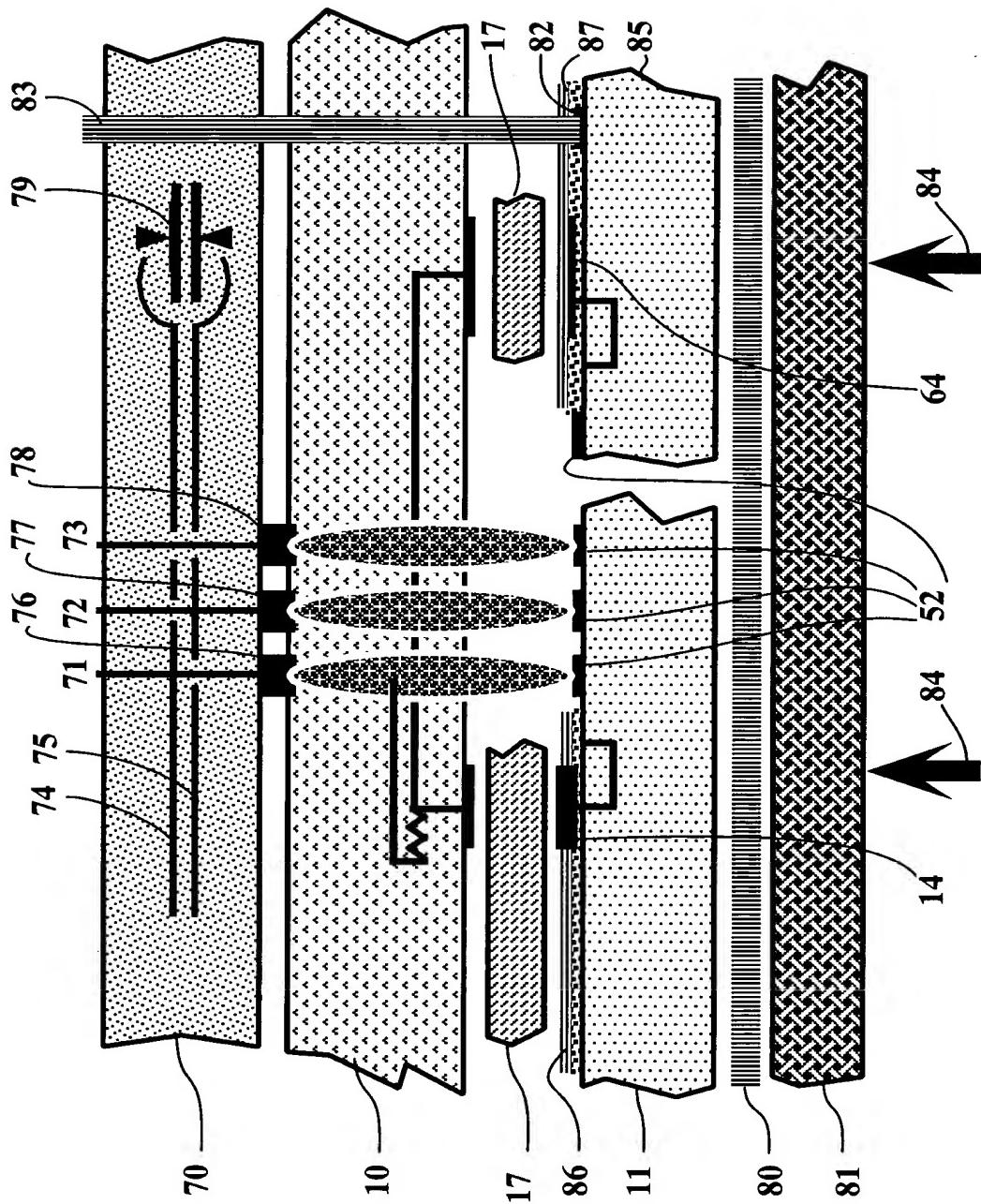
Fig. 4





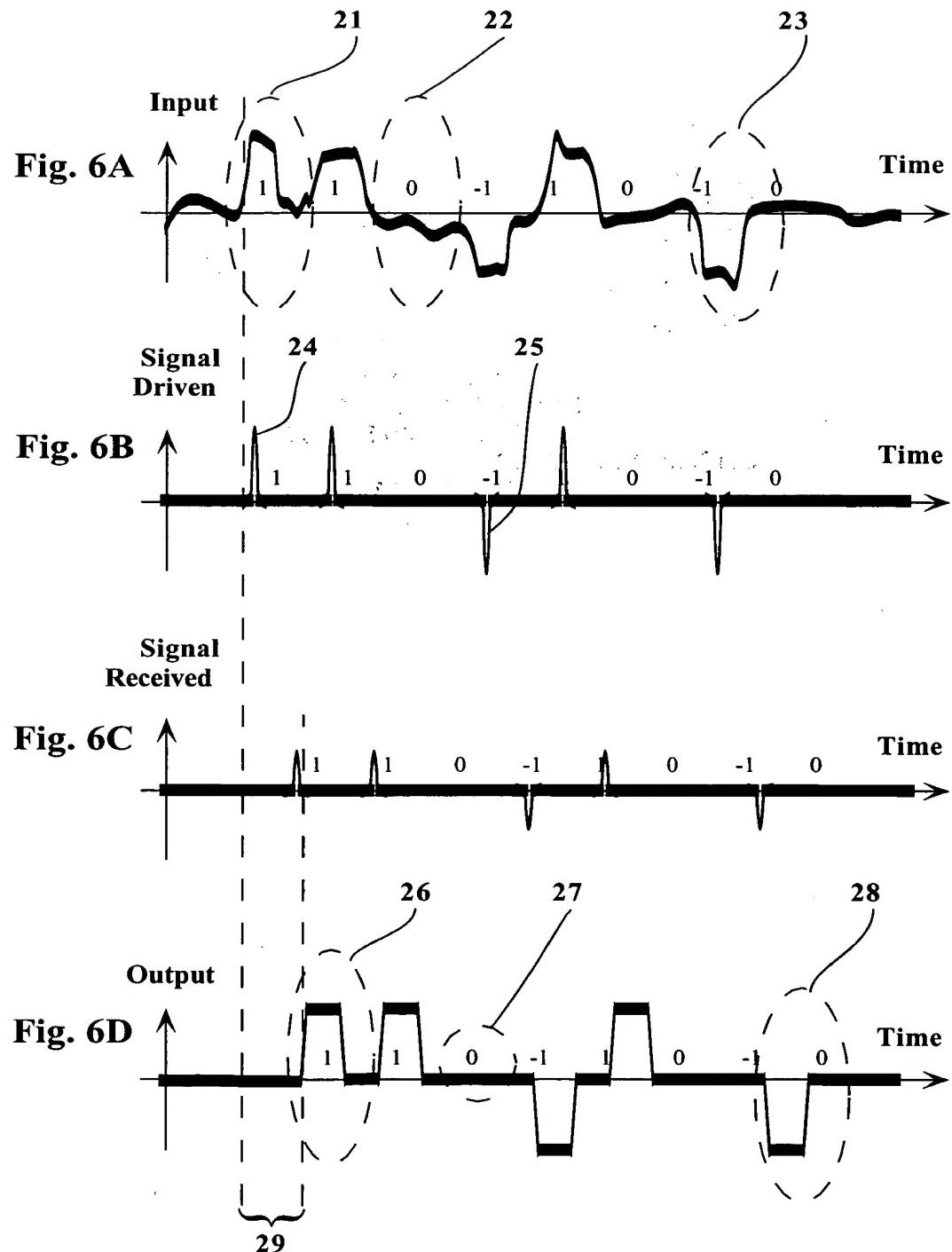
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Fig. 5





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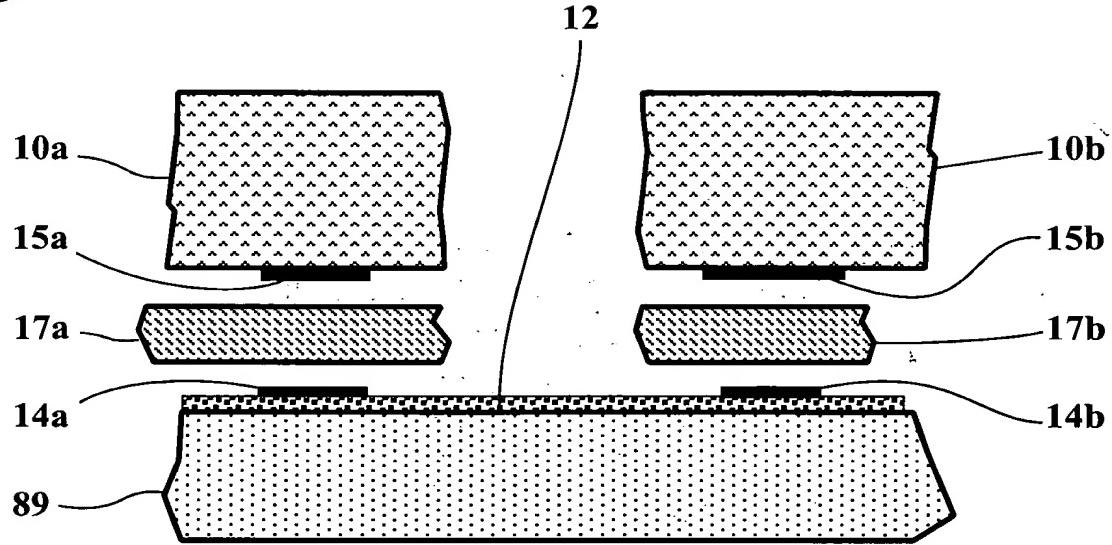


Fig. 7

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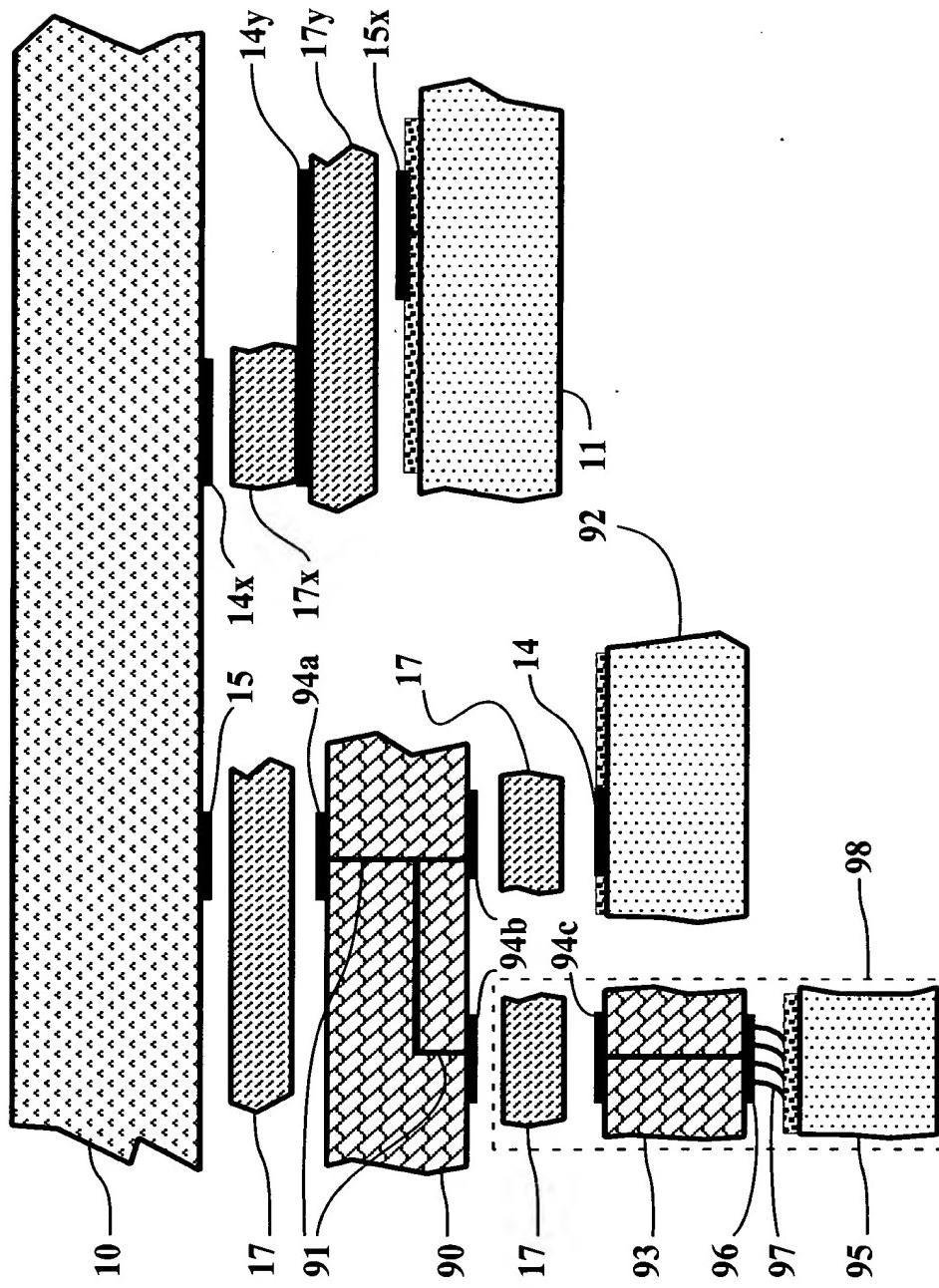


Fig. 8



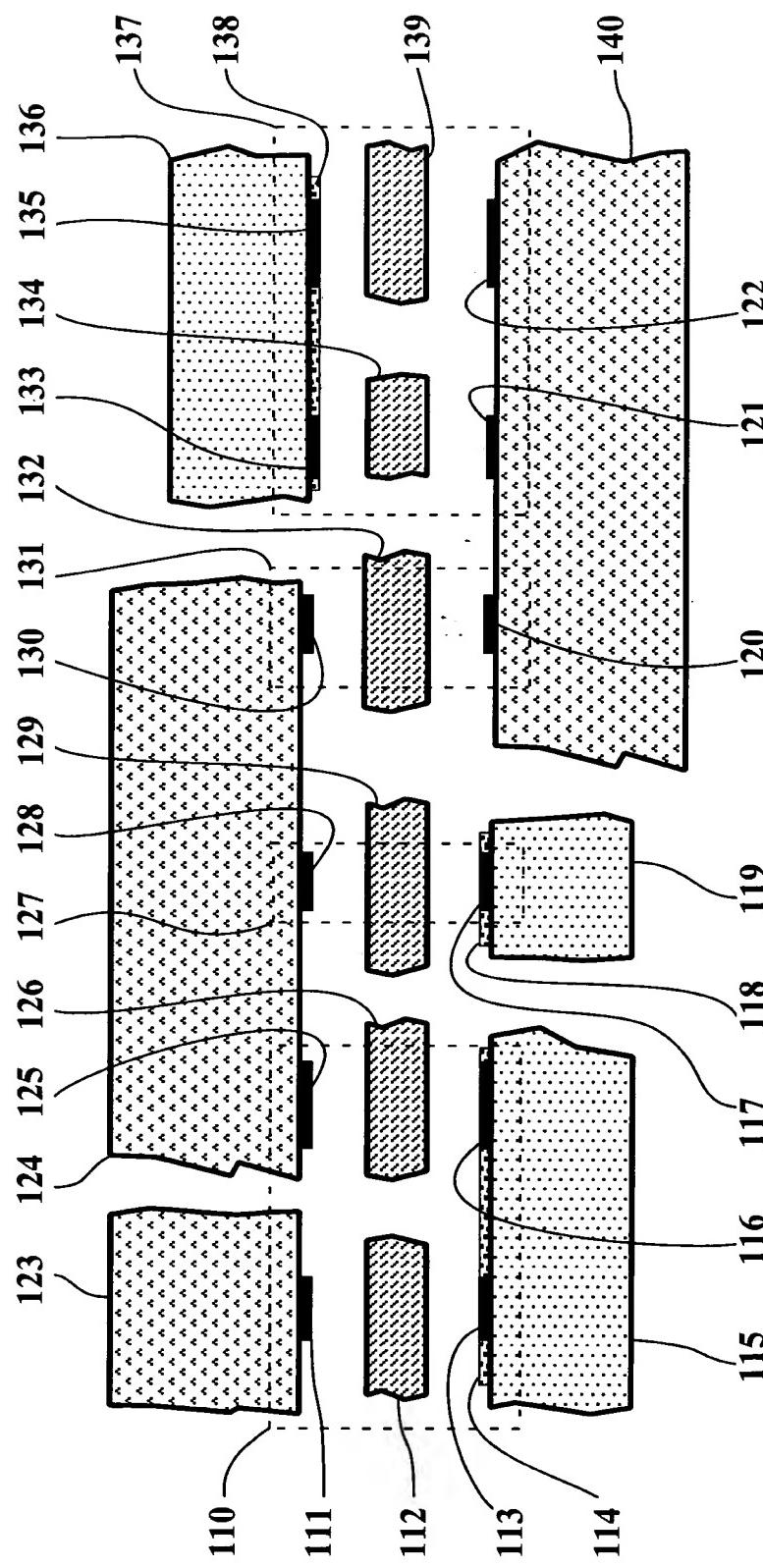


Fig. 9

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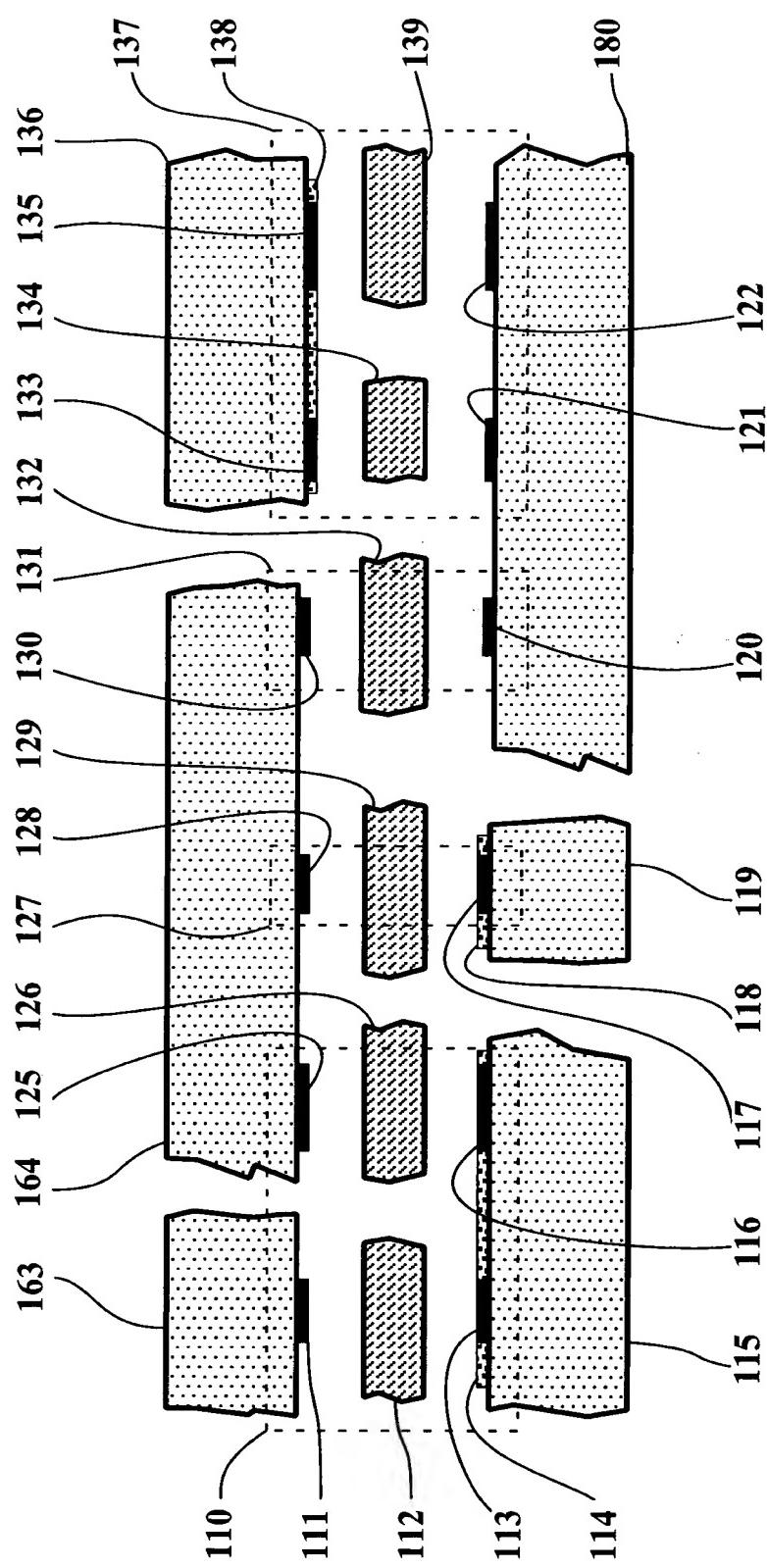


Fig. 10

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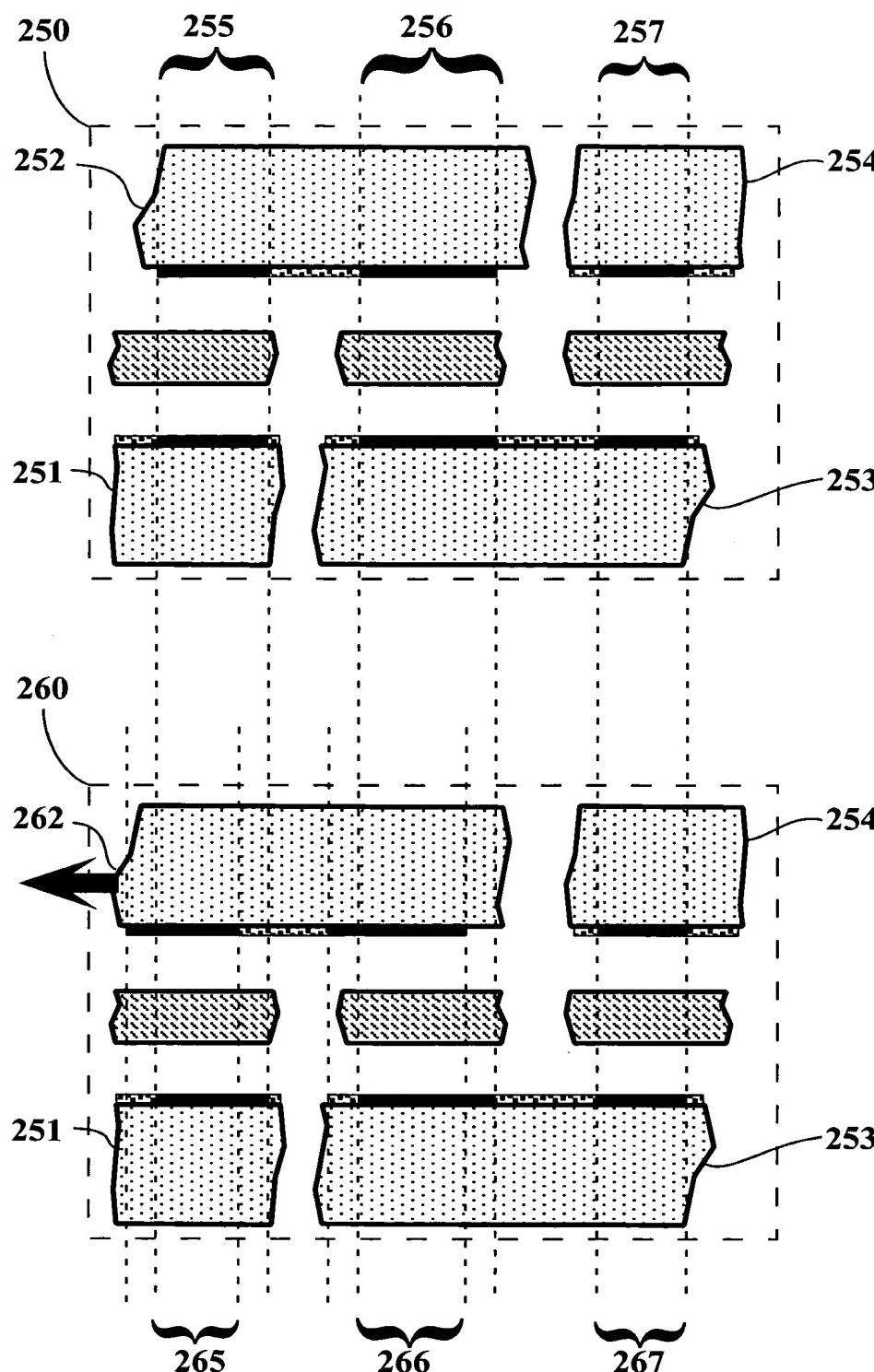


Fig. 11A

Fig. 11B

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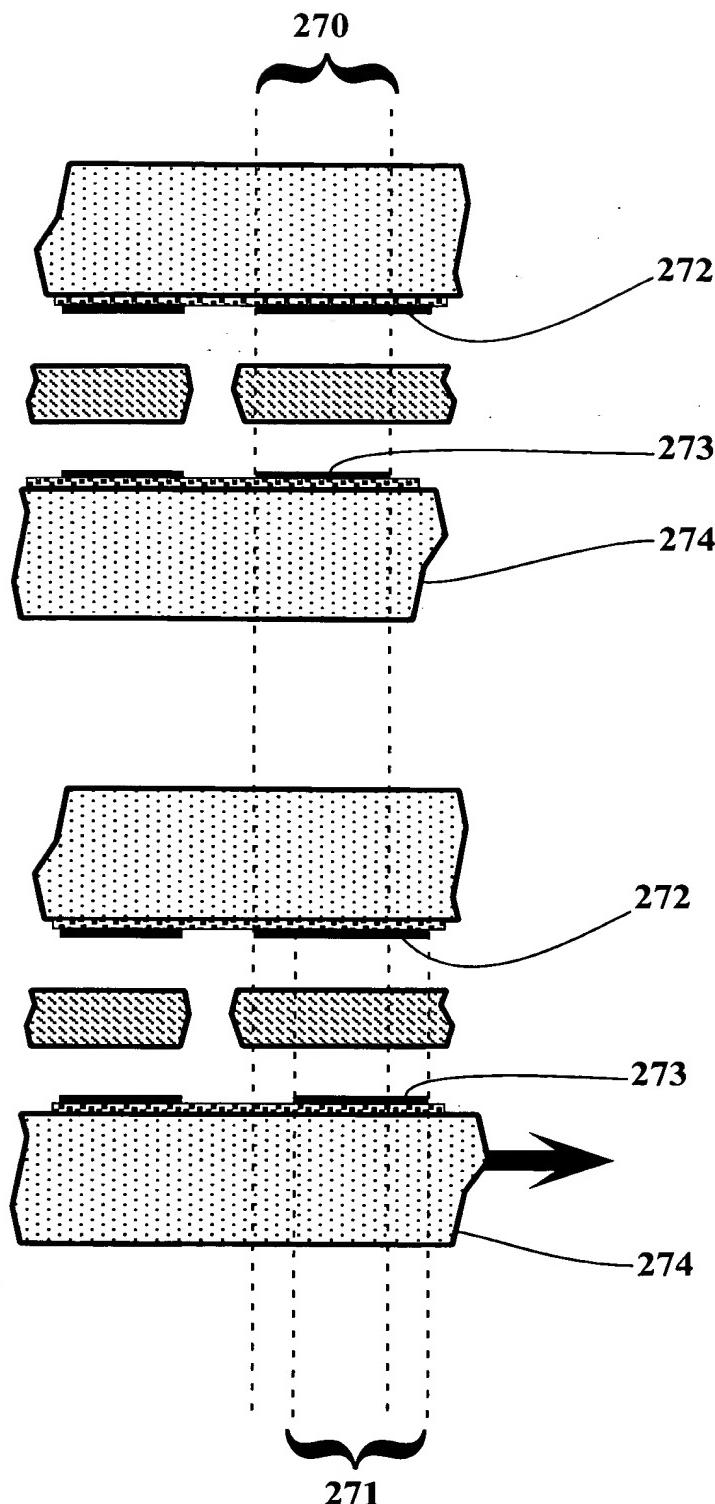


Fig. 12A

Fig. 12B

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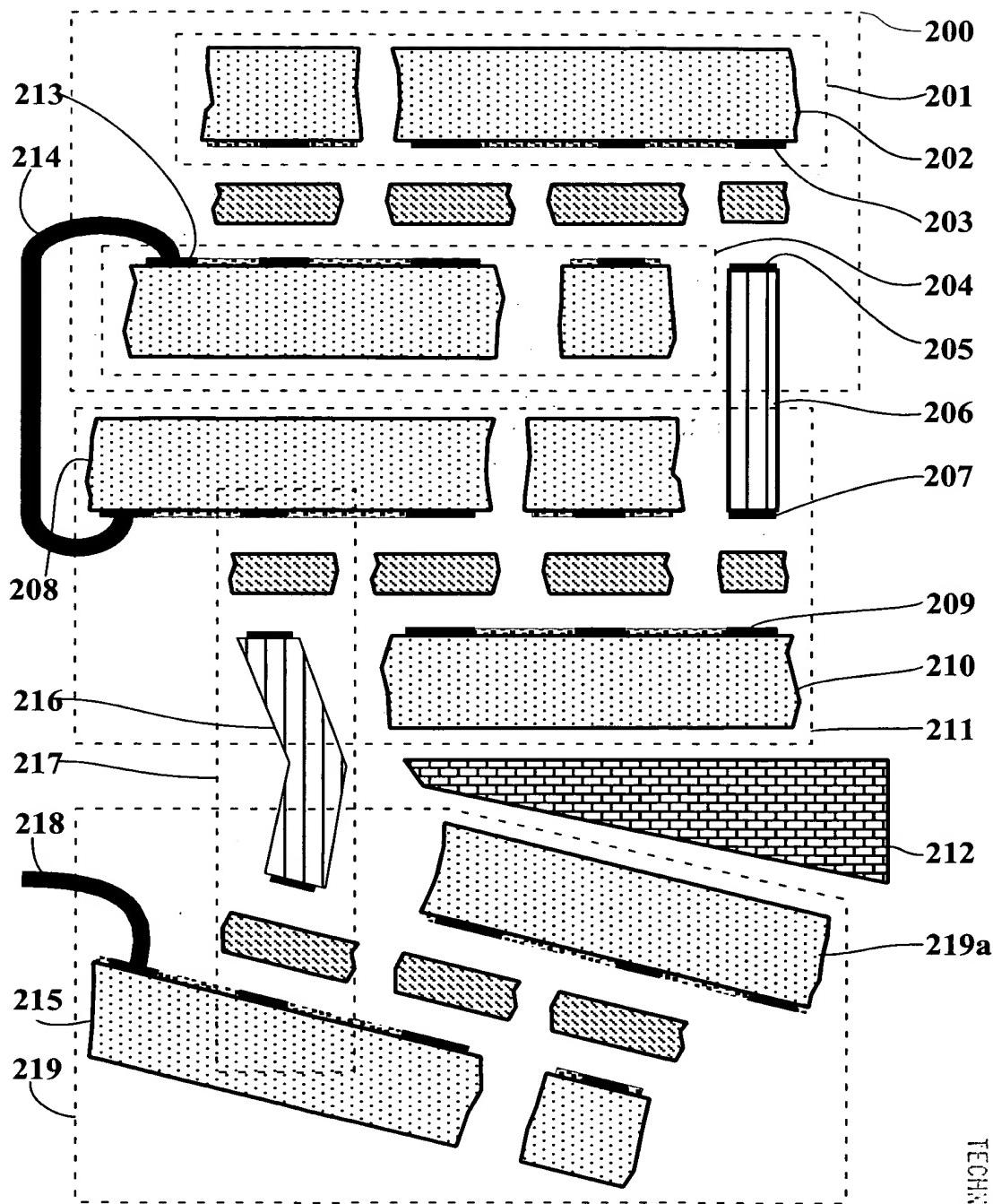


Fig. 13

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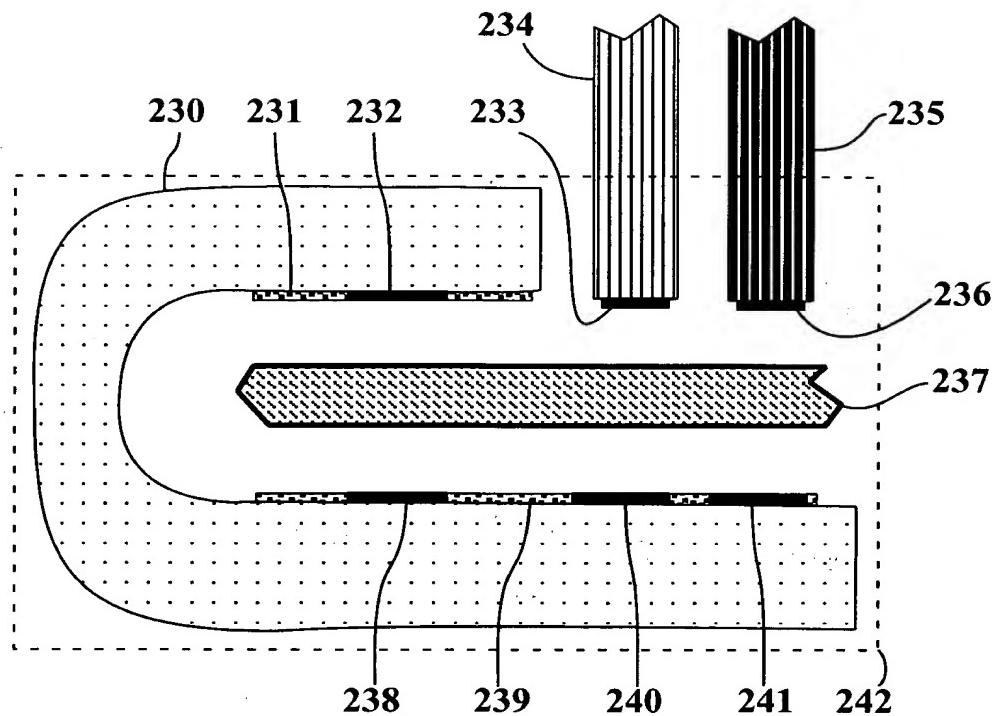


Fig. 14

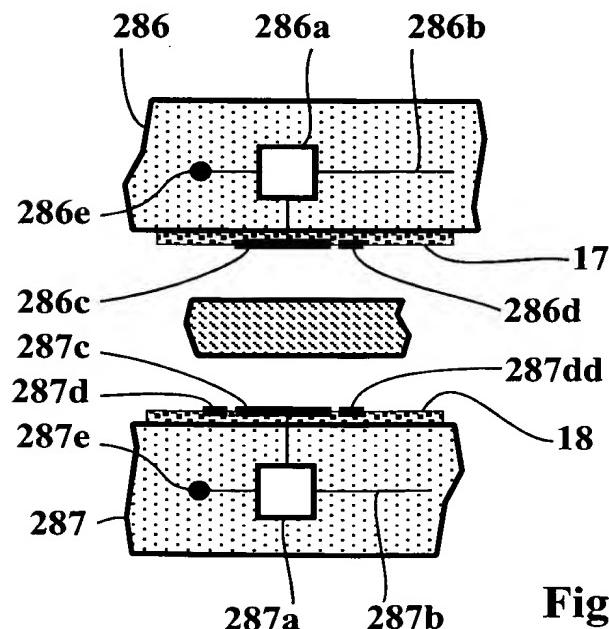


Fig. 19

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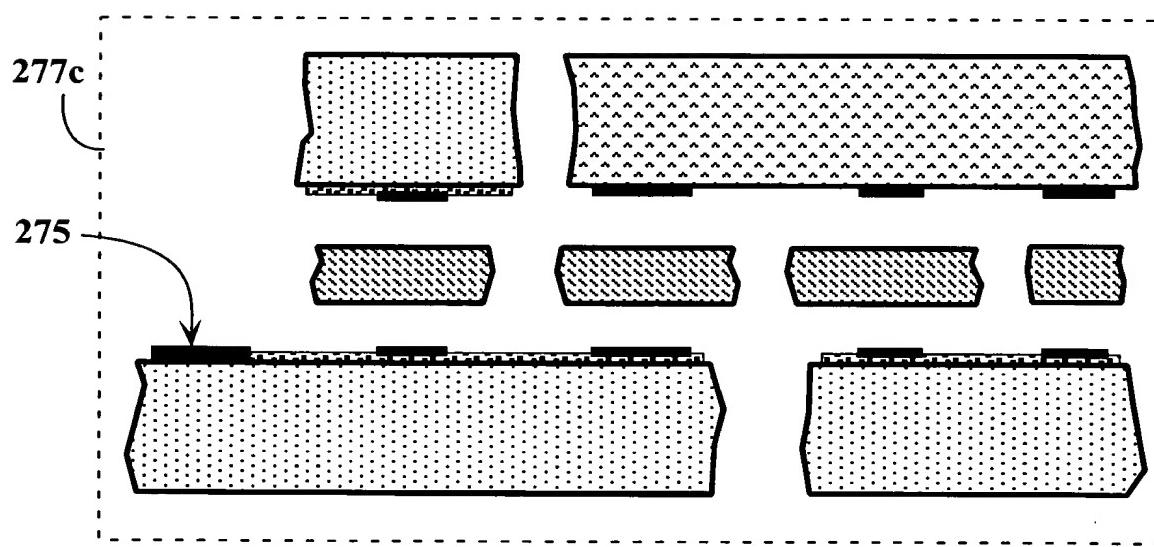
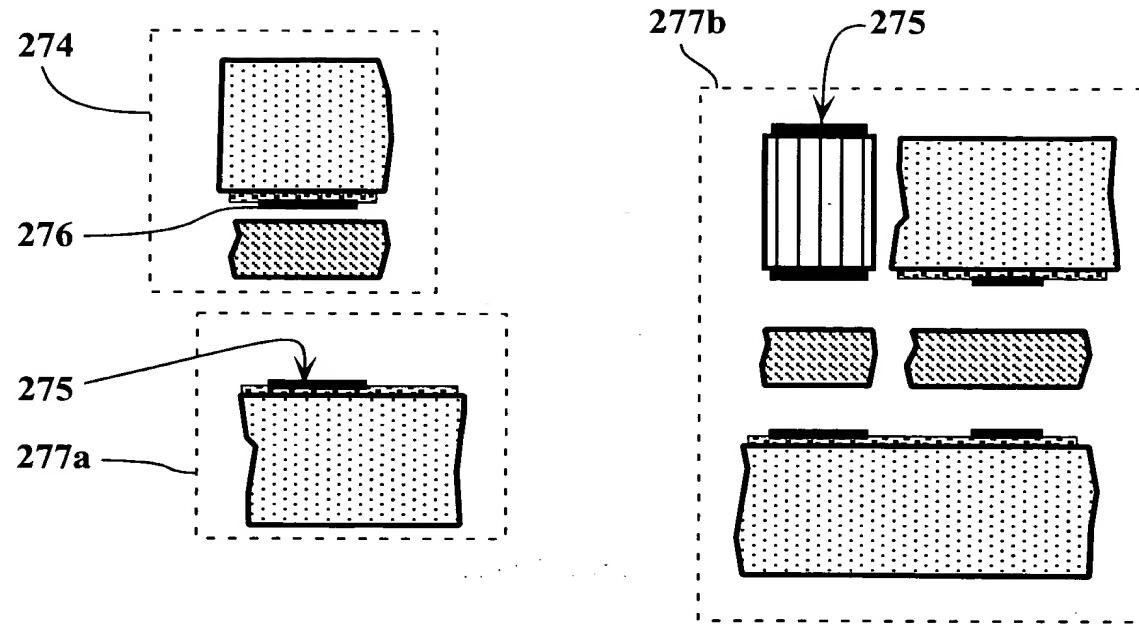


Fig. 15



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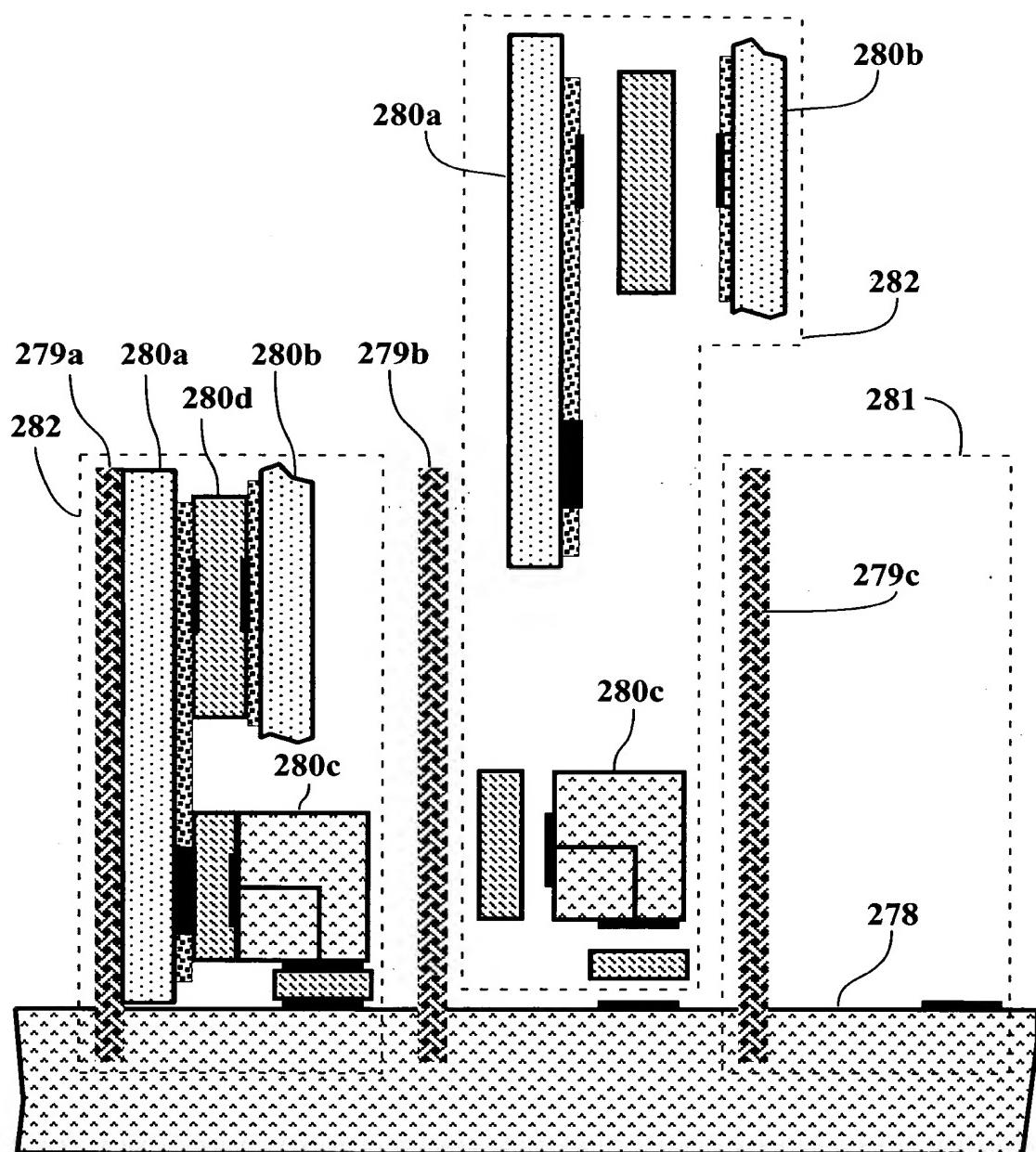
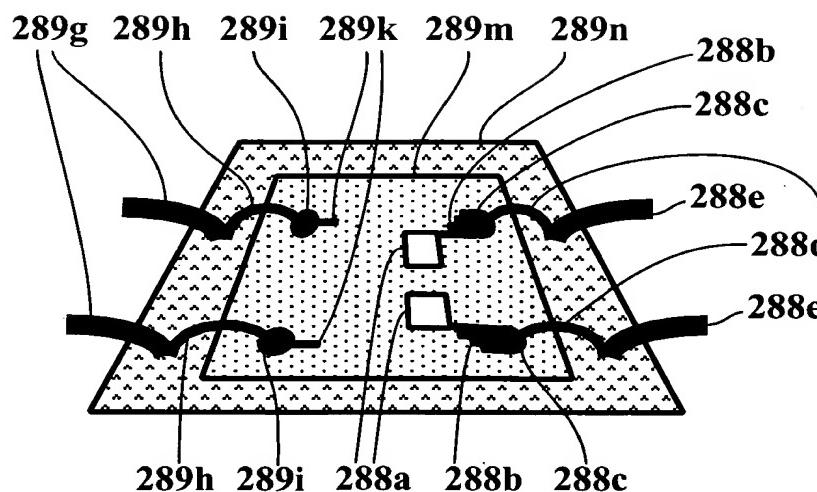


Fig. 16



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**Fig. 17A
(Prior Art)**

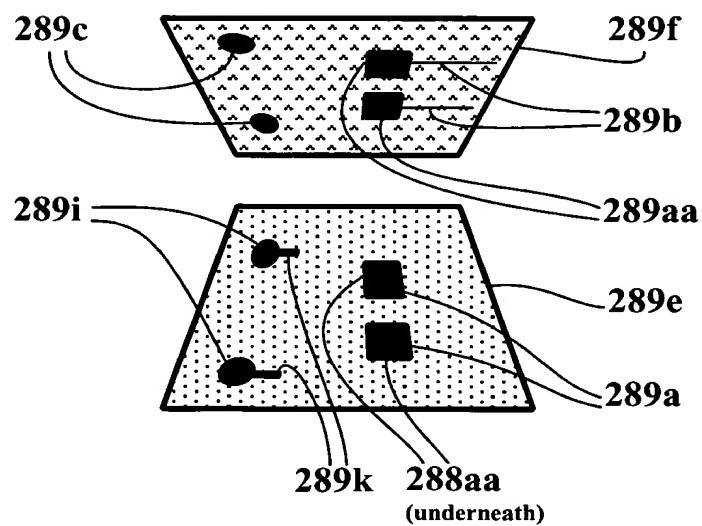
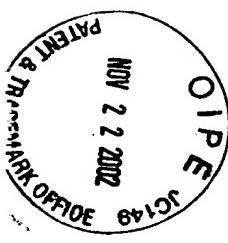


Fig. 17B



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Fig. 18A

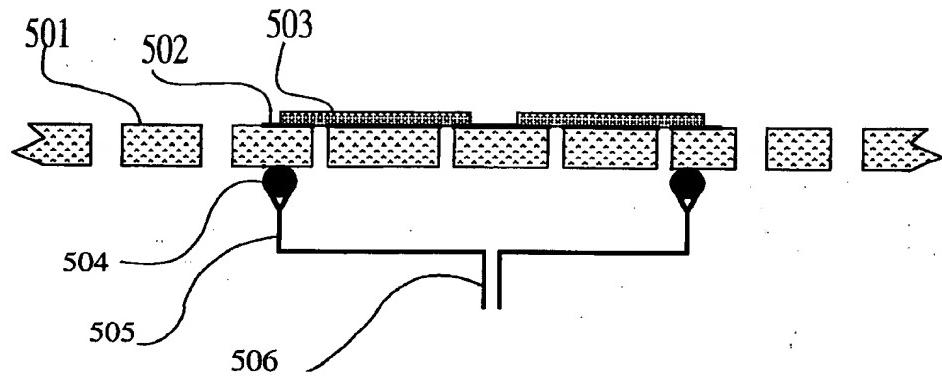


Fig. 18B

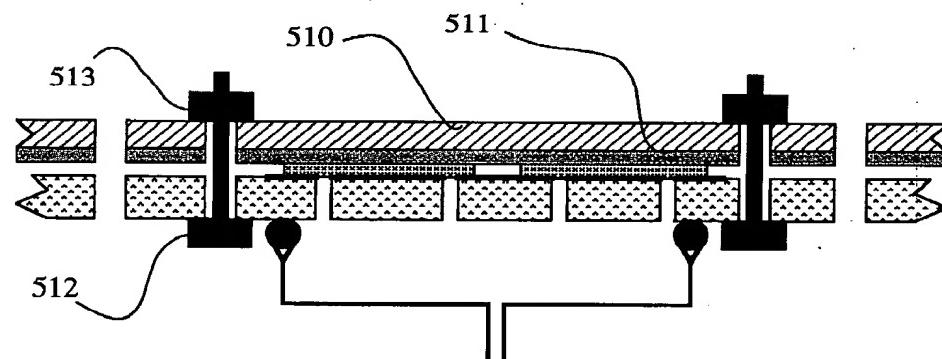
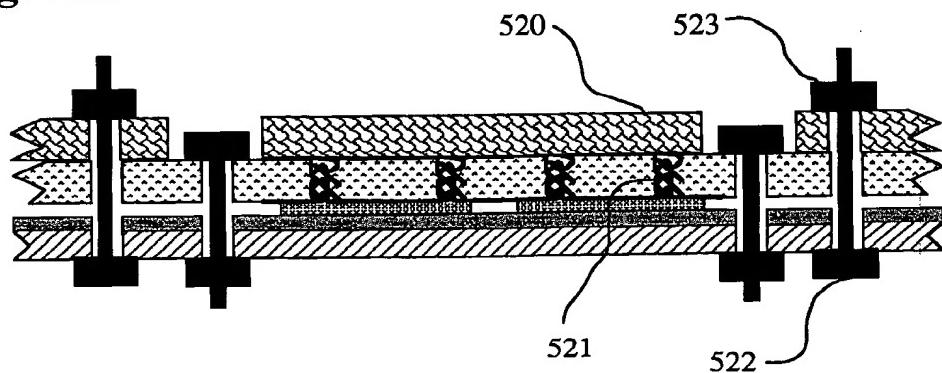


Fig. 18C



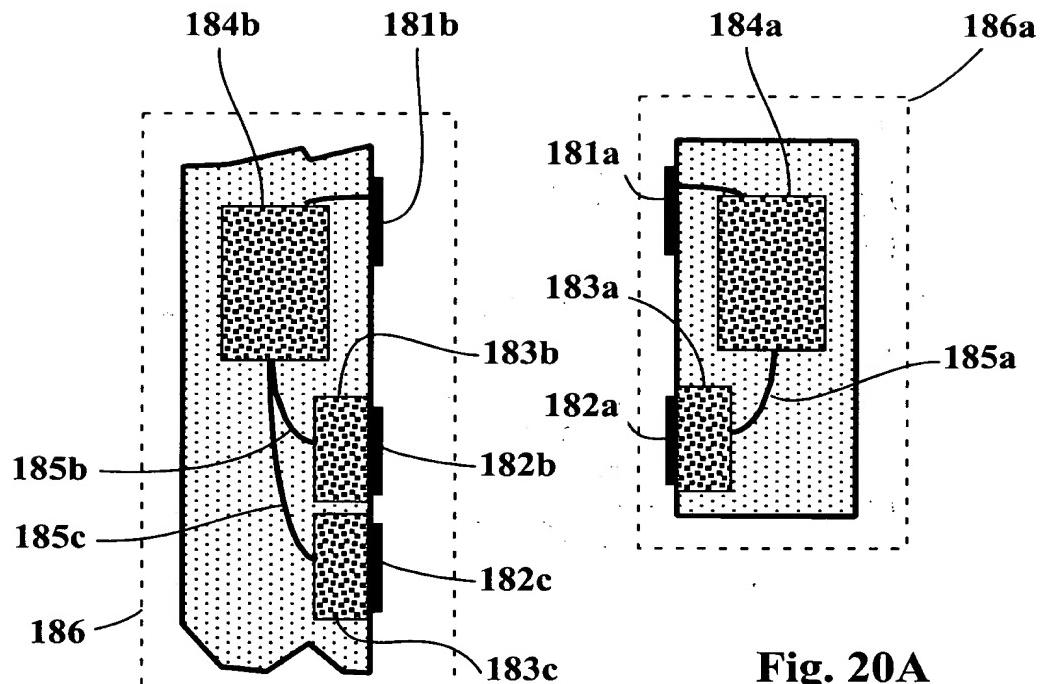


Fig. 20A

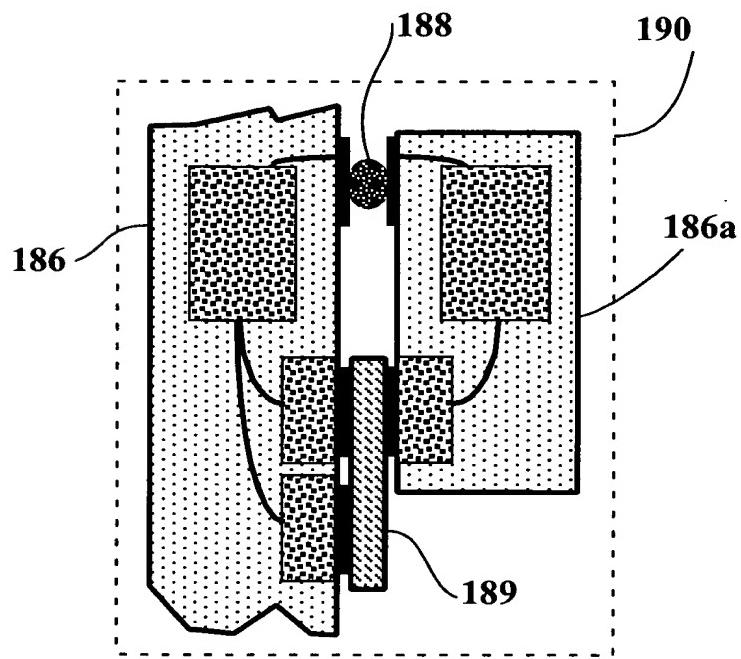


Fig. 20B

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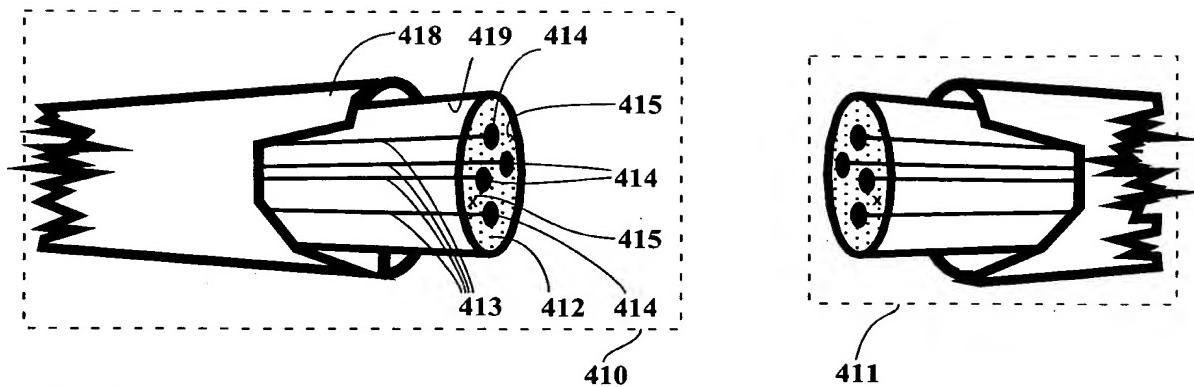
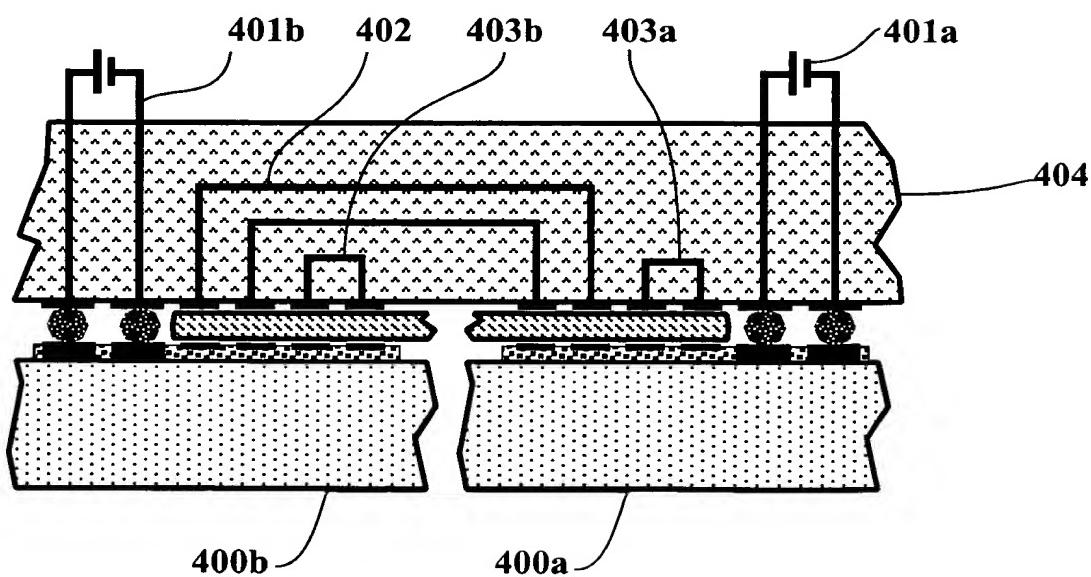


Fig. 21

Fig. 22



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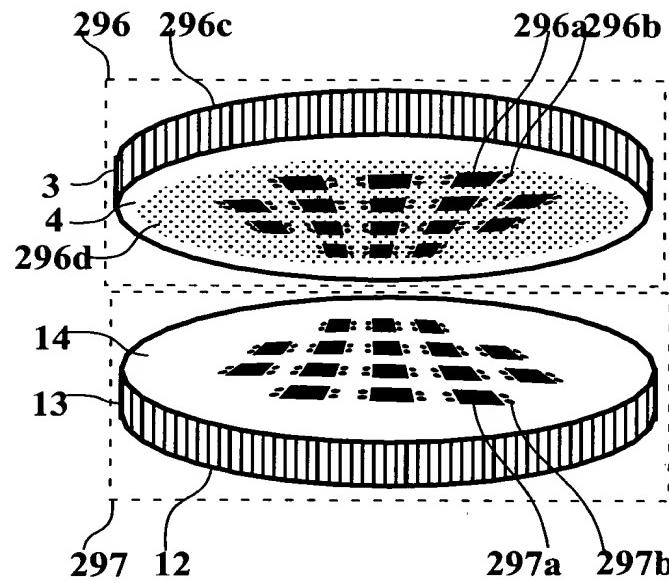


Fig. 23A

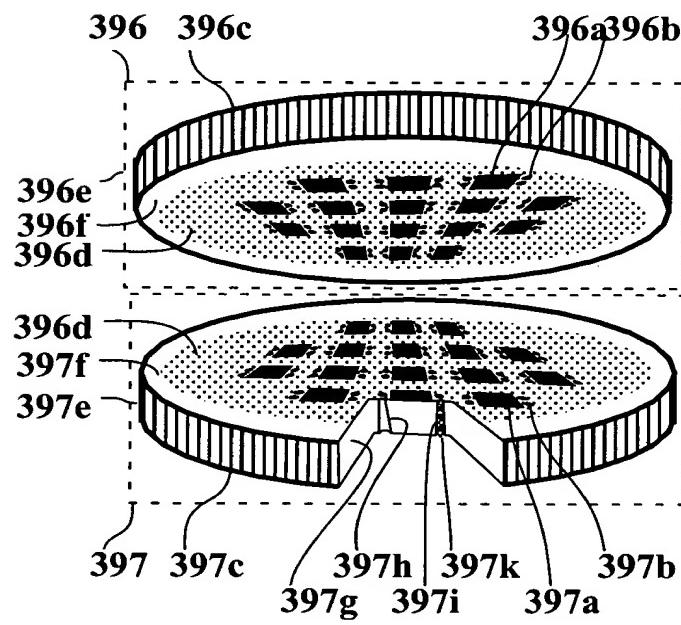
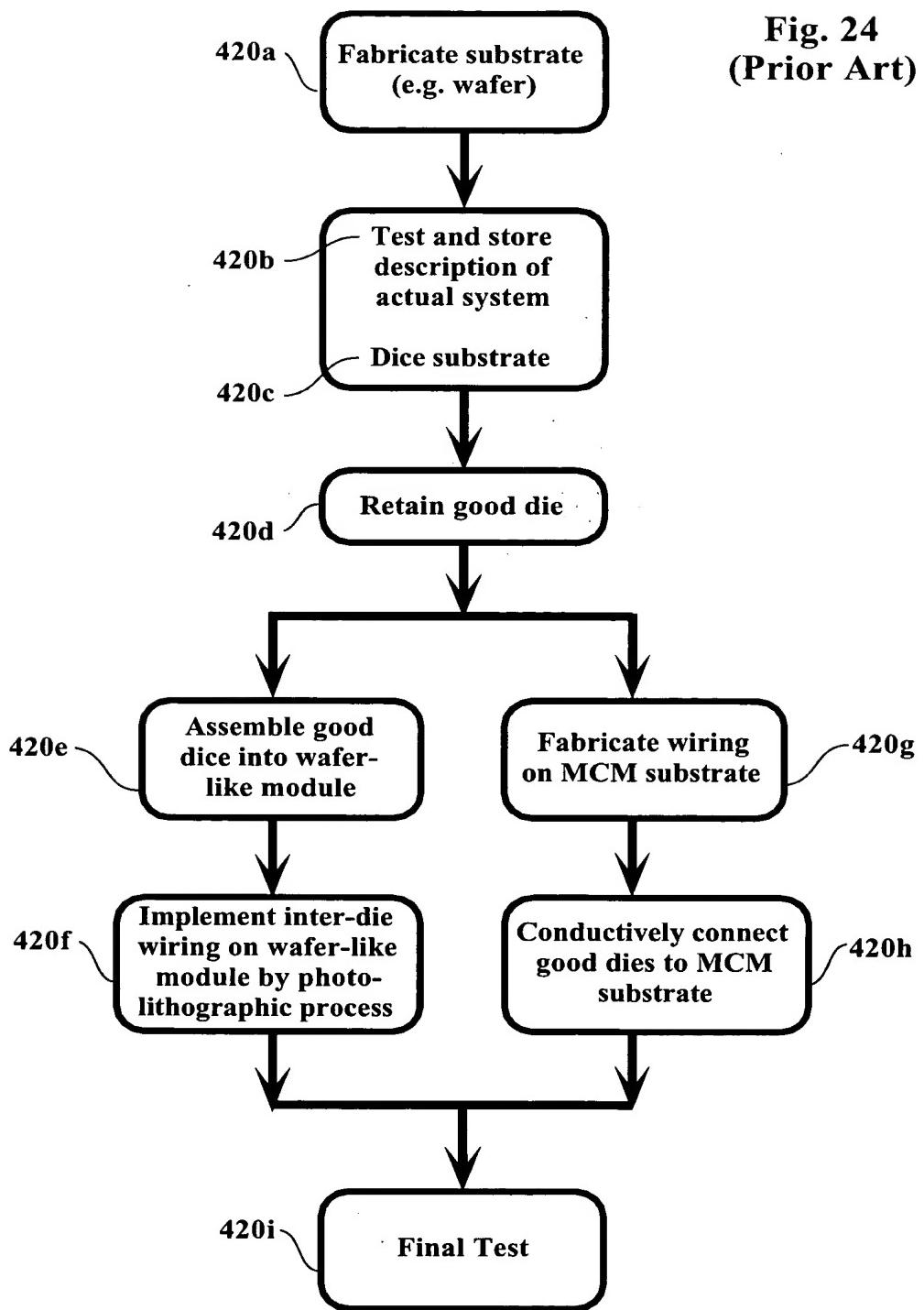


Fig. 23B

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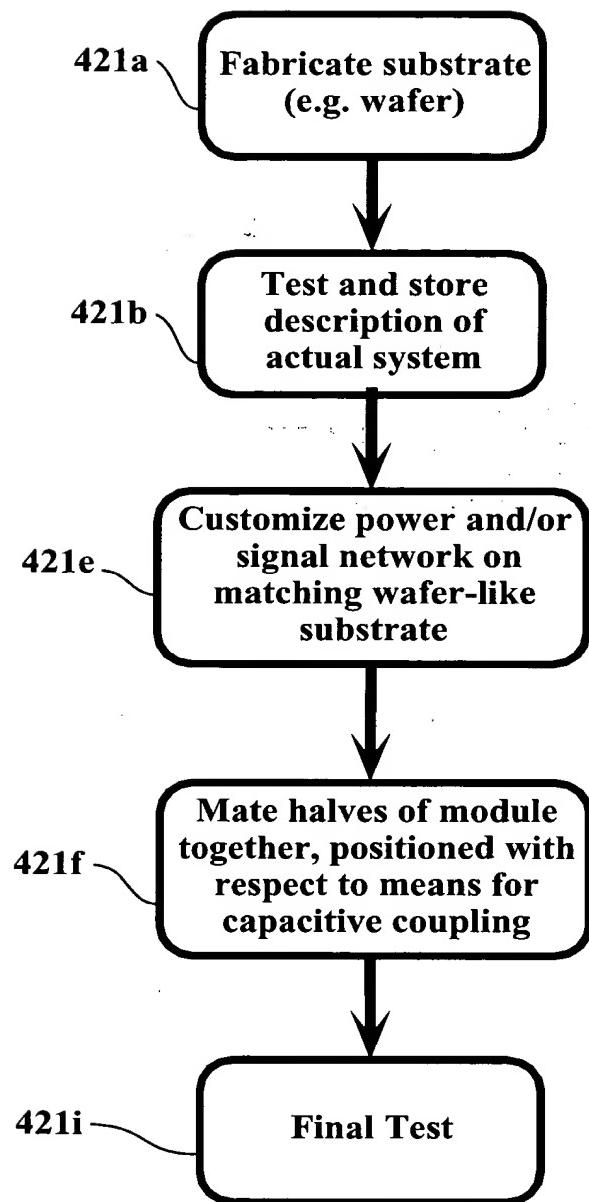
Fig. 24
(Prior Art)



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Fig. 25

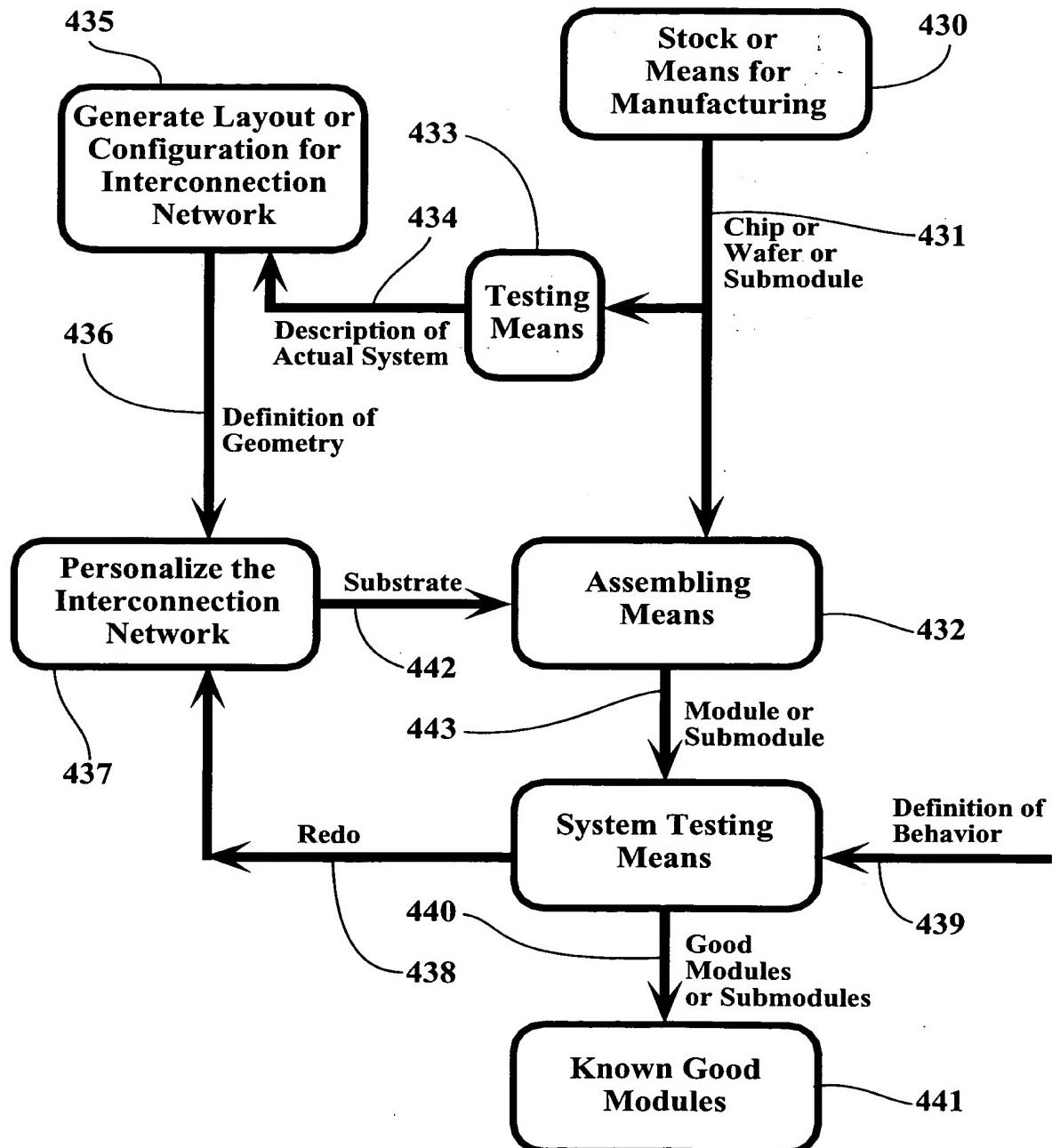


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Fig. 26





Yield for an Average of 1 Fault per cm²

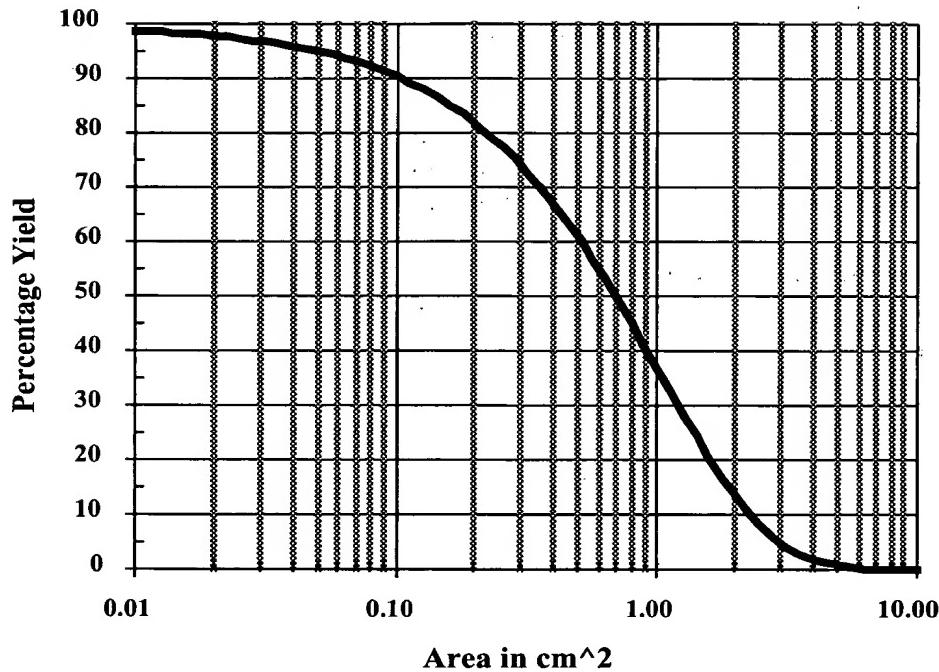


Fig. 27

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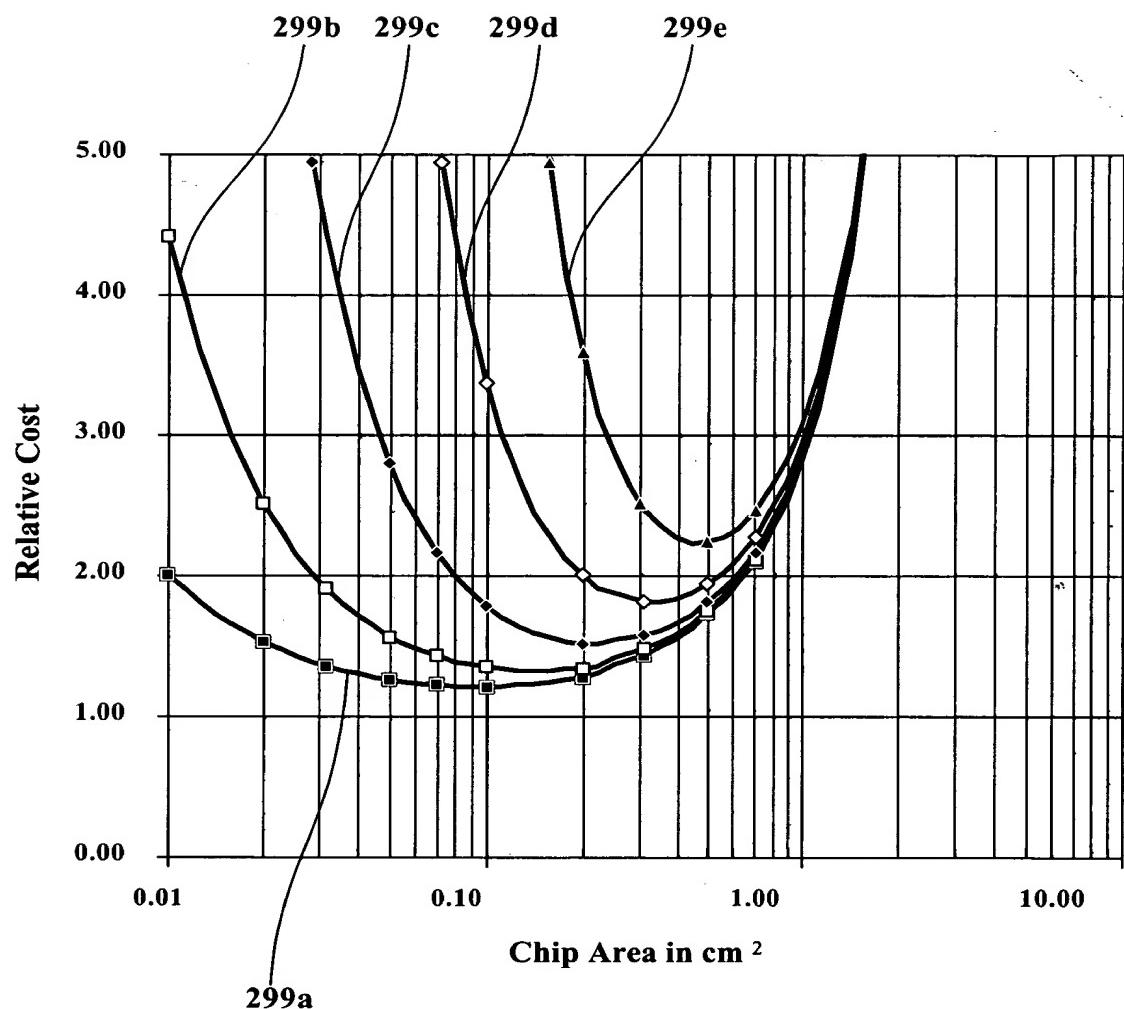


Fig. 28

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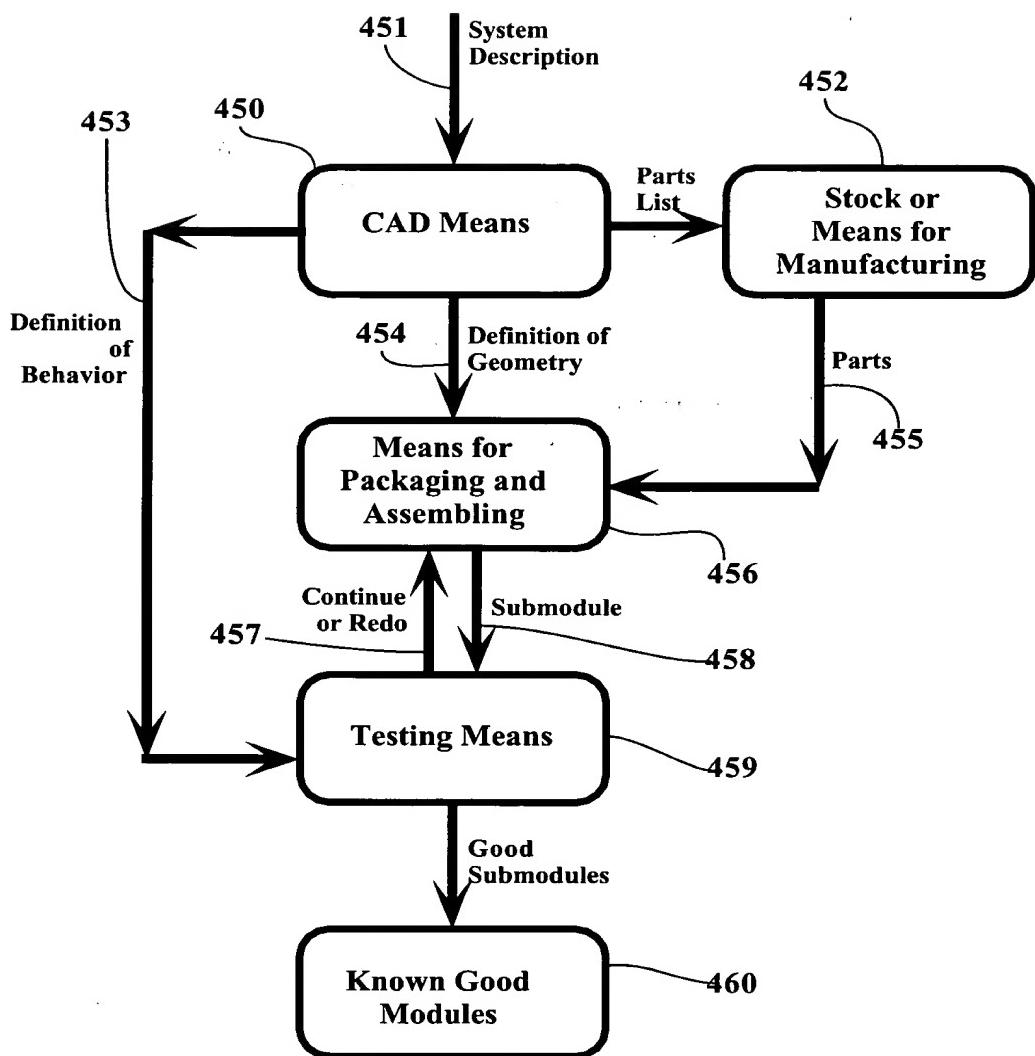


Fig. 29

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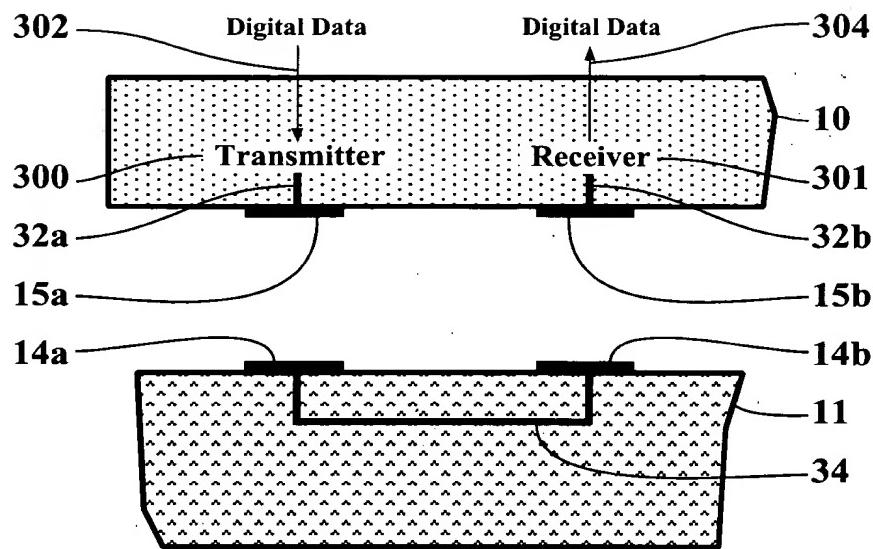


Fig. 30

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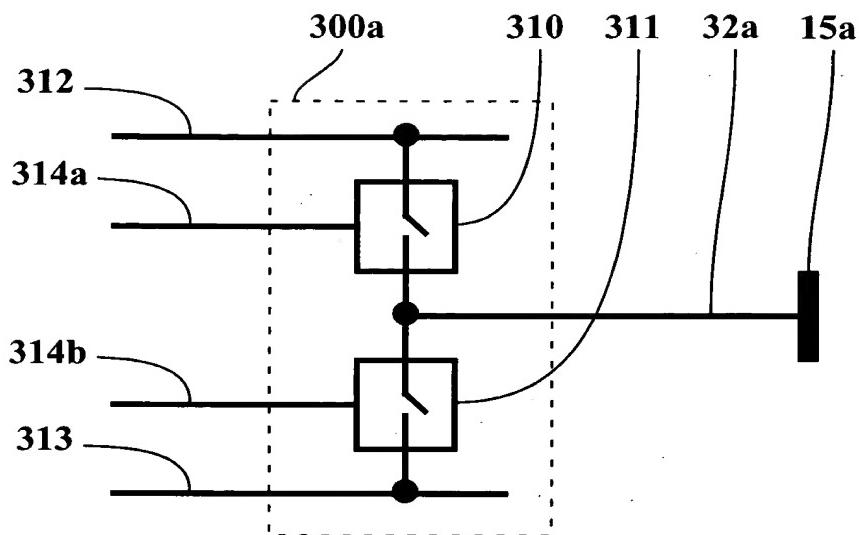


Fig. 31A

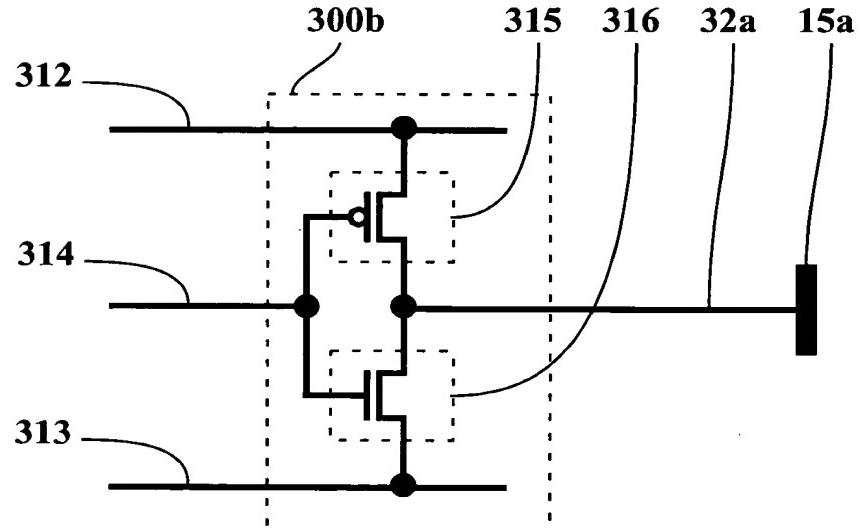


Fig. 31B

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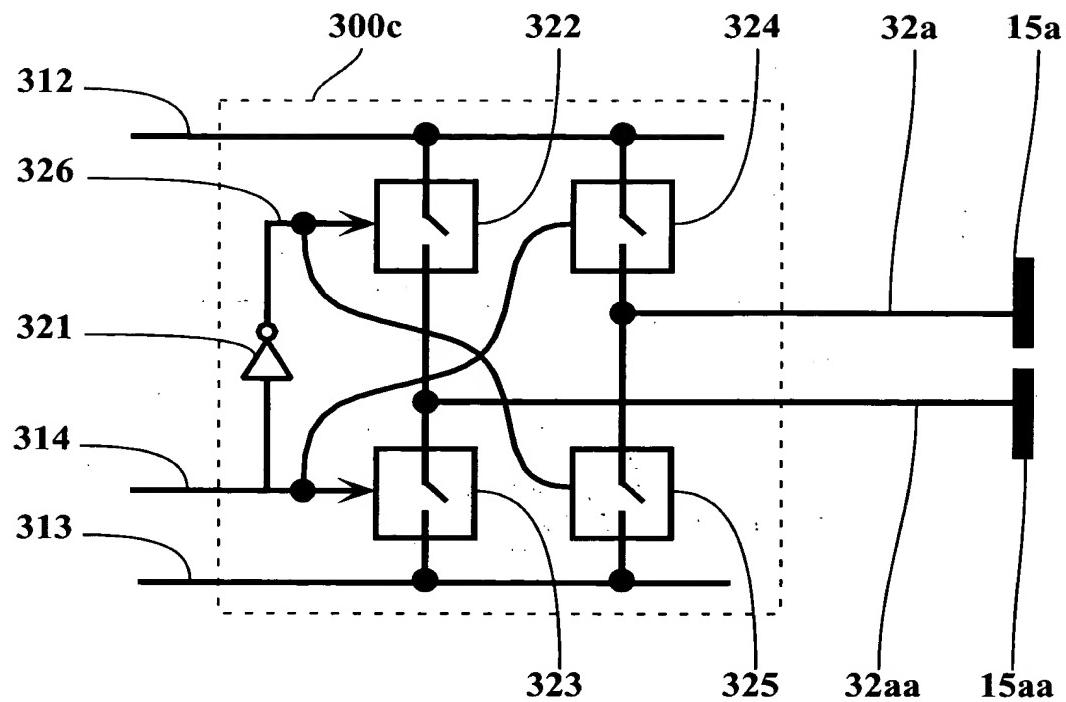


Fig. 32

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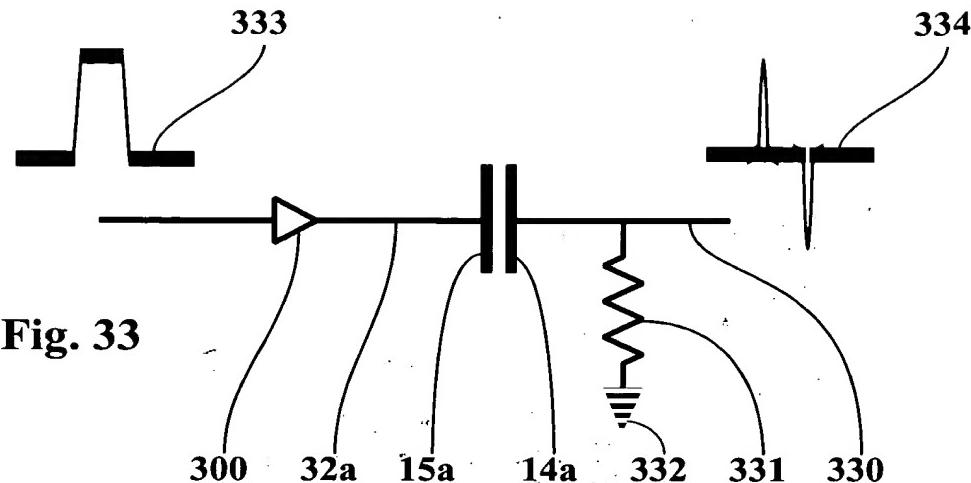


Fig. 33

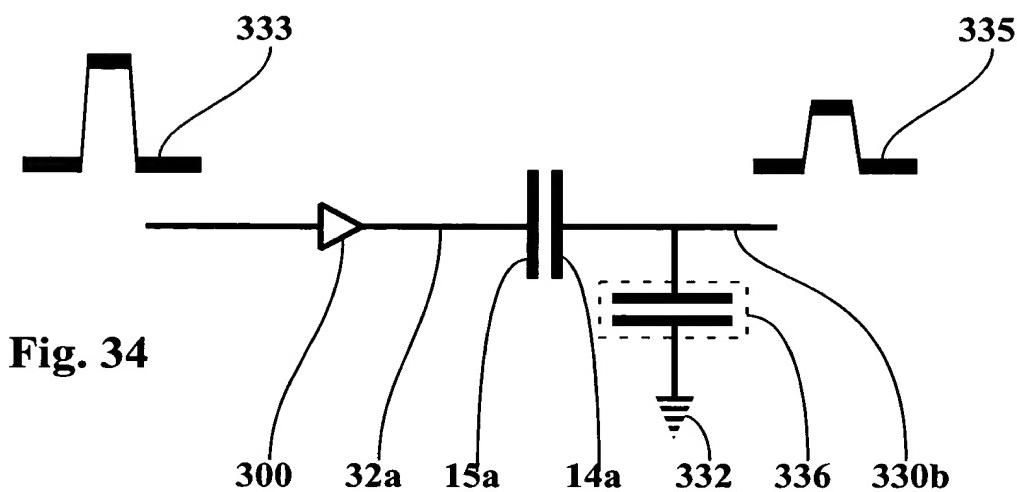


Fig. 34

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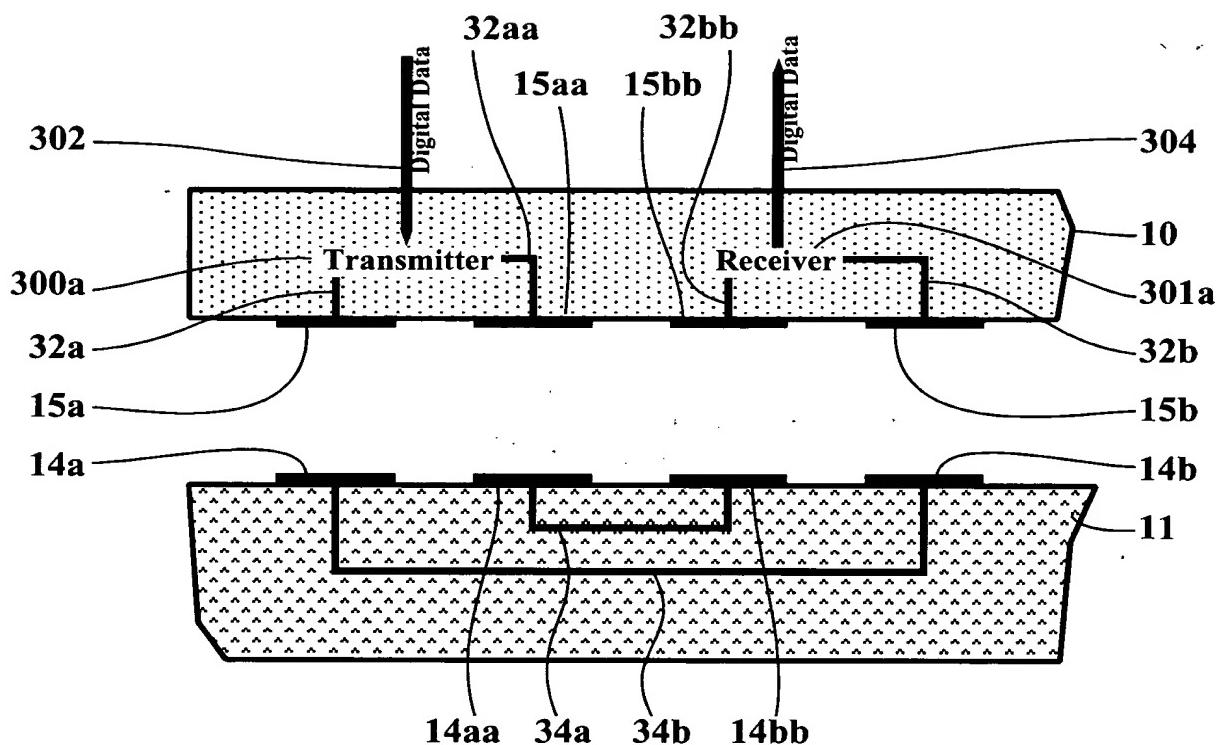


Fig. 35

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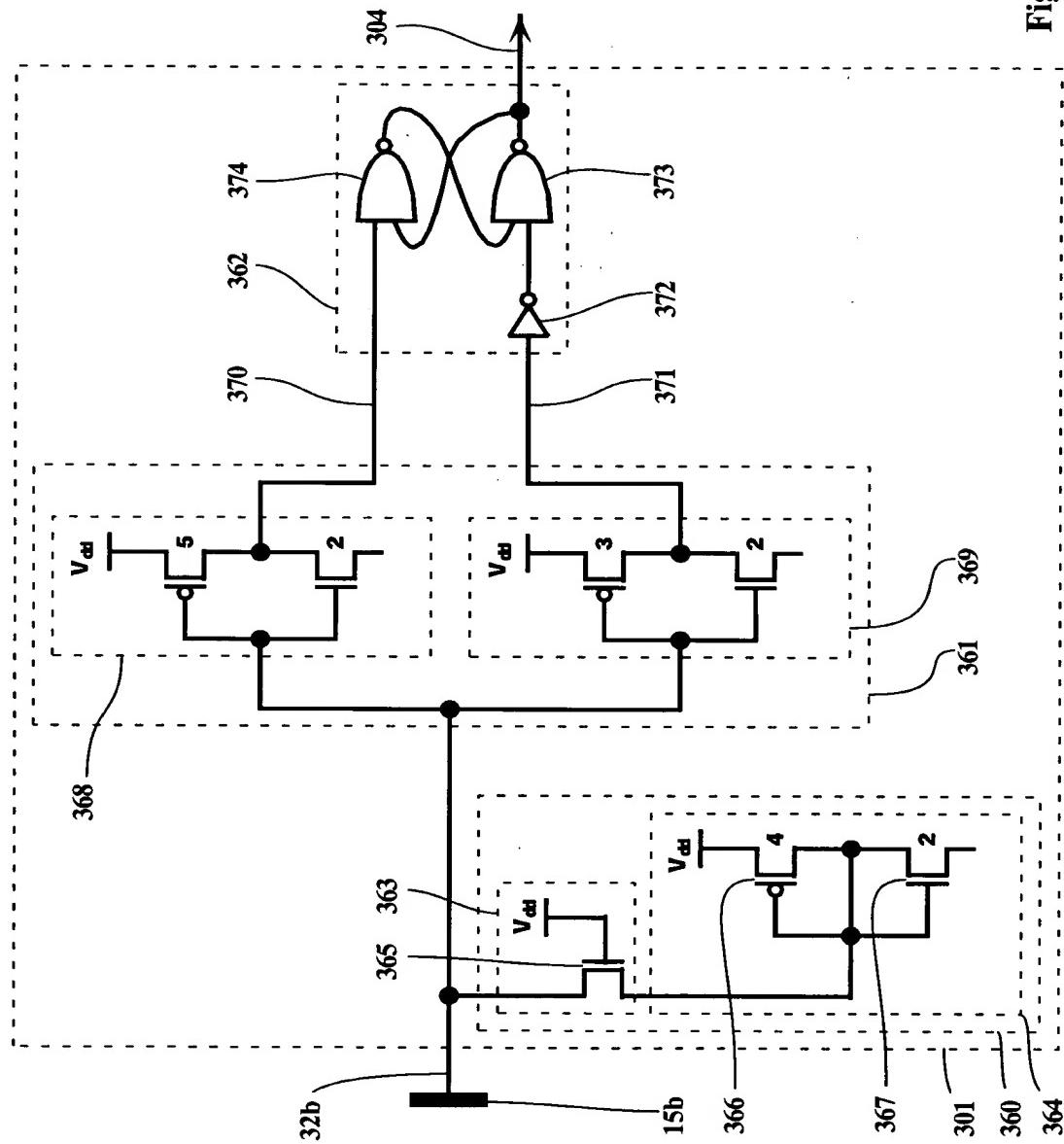
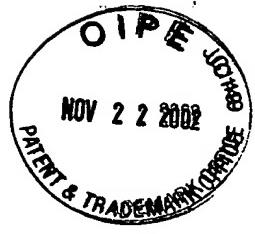


Fig. 36



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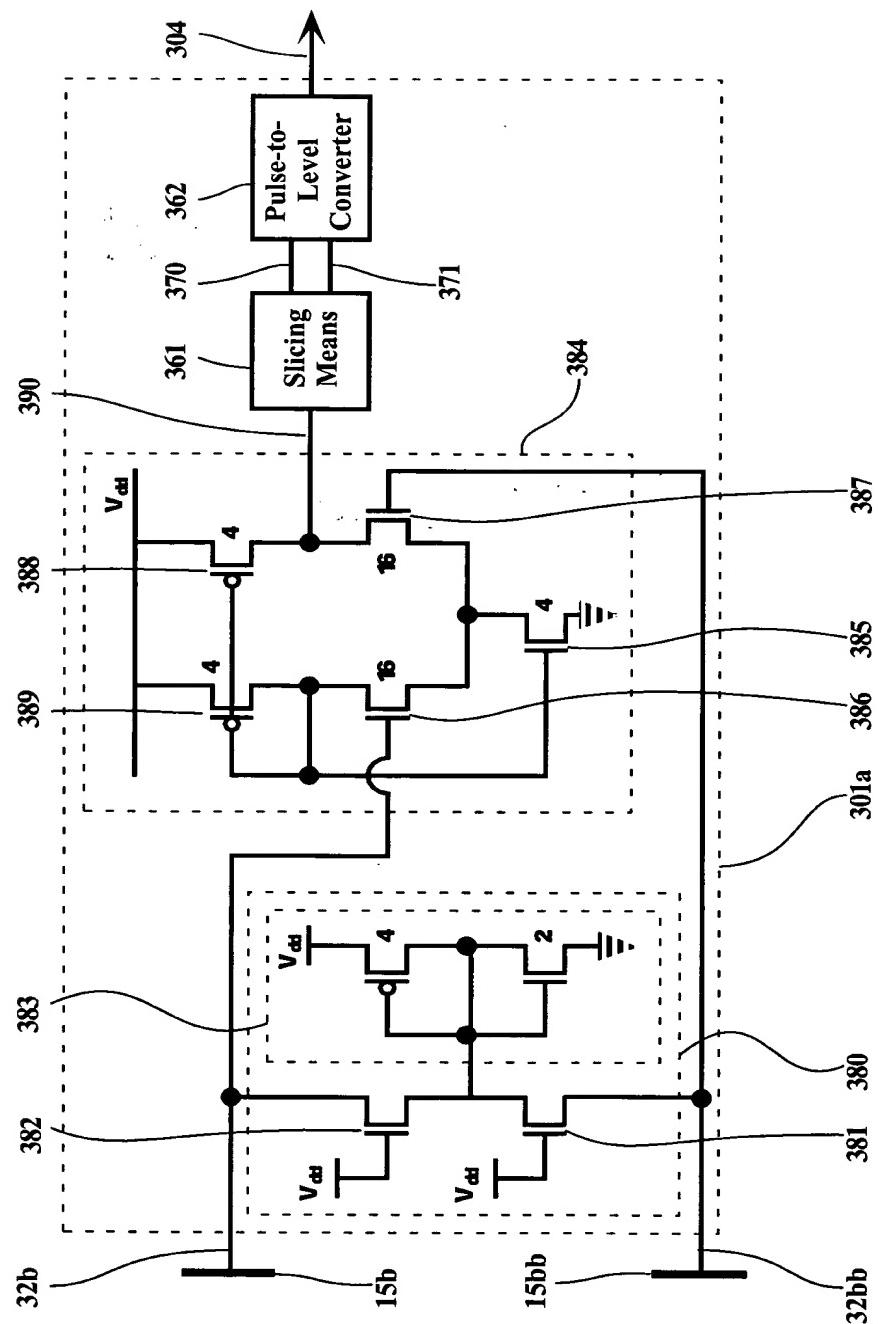


Fig. 37



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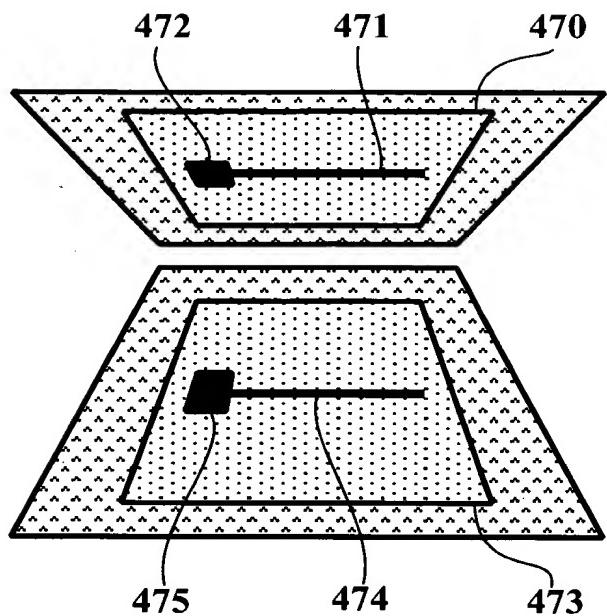


Fig. 38A

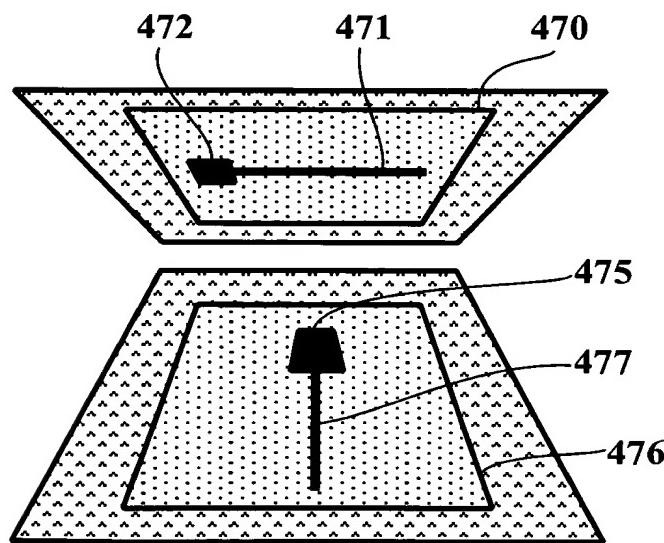


Fig. 38B